FORM PTO-1595 (Rev. 6-93) OMB No. 0651-0011 (exp. 4/94)	06-11-200	7
To the Honorable Commission		
1. Name of conveying party(ies):	10246945	
Seong-hyun Kim Sam-yong Bahng Yong-hyeon Kim Tae-Keun Jeon		Name: Samsung Electronics, Co., Ltd. Internal Address:
Additional name(s) of conveying party(ies) attached	? □ Yes ☒ No	100
3. Nature of conveyance:	L les B No	Street Address: 416, Maetan-dong, Paldal-gu,
3. Nature of conveyance.		Suwon-city, Kyungki-do, Republic of Korea
	☐ Merger	current toly, 12, magna 20, 20, 20, 20, 20, 20, 20, 20, 20, 20,
☐ Security Agreement ☐ Other	☐ Change of Name	City: State ZIP
Execution Date: May 27, 2003		Additional name(s) & address attached? ☐ Yes ☒ No
	Additional numbers attack	hed? □ Yes ⊠ No
5. Name and address of party to whom cor document should be mailed:	respondence concerning	6. Total number of applications and registrations involved
Name: Anthony P. Onello, Jr.		
Internal Address:MILLS & ONE	LLOLLP	7. Total fee (37 CFR 3.41) \$40.00
Internal Address. With Est & GIVE	350 551	⊠ Enclosed
		☐ Authorized to be charged to deposit account
Street Address: Eleven Beacon S	Street, Suite 605	8. Deposit Account Number:
City: Boston State	MA ZIP 02108	(Attach duplicate copy of this page if paying by deposit account)
06/10/2003 GTON11 00000147 10453989	DO NOT USI	E THIS SPACE
9. Statement and signature: To the best of my knowledge and belief, the document.	p coregoing information is	true and correct and any attached copy is a true copy of the original
Anthony P. Onello, Jr. Reg. No. 38,57	<u> </u>	Retting Portly Jul 4, 2003
Name of Person Signing  Total number of page	Signat s including cover sheet, att	ure Date

Mail documents to be recorded with required cover sheet information to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Reference No.:SAM-0473

## ASSIGNMENT

We, Seong-hyun Kim, of 520-301, Samsung 5 cha, 1167 bunji, Pungdukchunri, Suji-eup, Yongin-shi, Kyunggi-do, Republic of Korea; Sam-yong Bahng, of 308-1904, Kyunyoung Mugigae, Gumi-dong, Bundang-ku, Sungnam-shi, Kyunggi-do, Republic of Korea; Yong-hyeon Kim, of 508-701, Samsung 5 cha Apt., Jinsan maeul, 1168 bunji, Pungdukchunri, Suji-eup, Yongin-shi, Kyunggi-do, Republic of Korea; and Tae-Keun Jeon, of 402, Maronie-dong, san 7-1, Nongsuri, Kyheung-eup, Yonginshi, Kyunggi-do, Republic of Korea; having invented improvements in NON-VOLATILE SEMICONDUCTOR MEMORY DEVICE FOR CONNECTING TO SERIAL ADVANCED TECHNOLOGY ATTACHMENT CABLE described in an application for Letters Patent of the United States, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.

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F	irst	or	Sole	Inventor

Signature:

Seong hyun Kim

Second Joint Inventor:

Signature:

Sam-yong Bahng

Third Joint Inventor:

Signature: Yong-hyeon Kim

Date: 4/24 - 37, 2003

Fourth Joint Inventor:

Signature:

Jeen, Tar-kenn Tae-Keun Jeon

Date: May 21, 2.003

REFERENCE NO.: SAM-0473

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RECORDED: 06/04/2003

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PATENT REEL: 014142 FRAME: 0706